

EE130: Integrated Circuit Devices

(online at <http://webcast.berkeley.edu>)

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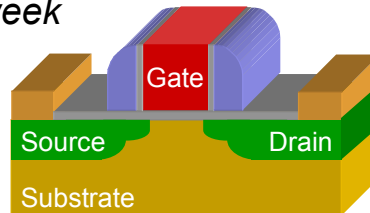
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Web page: <http://www-inst.eecs.berkeley.edu/~ee130/>

Newsgroup: ucb.class.ee130

Course Outline

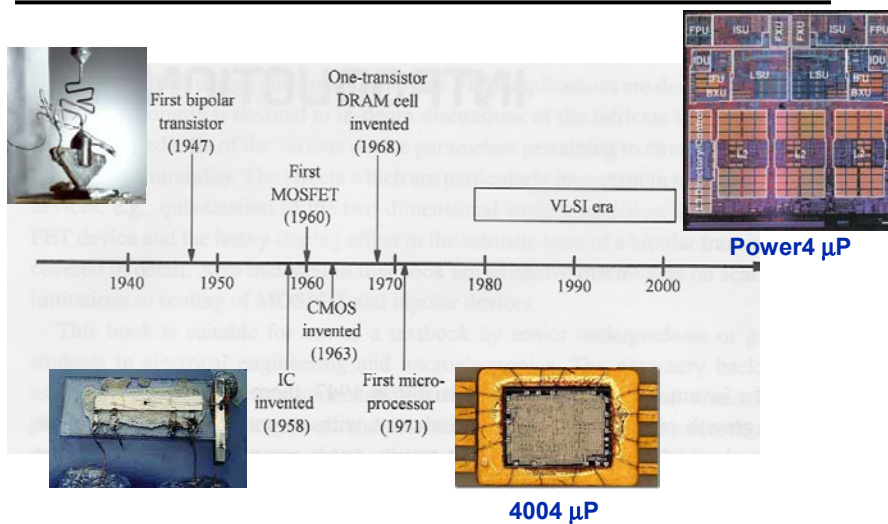
1. Semiconductor Fundamentals – *3 weeks*
2. Metal-Semiconductor Contacts – *1 week*
3. P-N Junction Diode – *3 weeks*
4. Bipolar Junction Transistor – *3 weeks*
5. MOS Capacitor – *1 week*
6. MOSFET – *4 weeks*



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Introduction

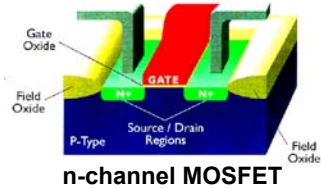
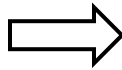
Integrated-Circuit Devices



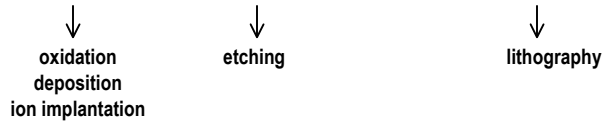
Planar Process Technology

starting substrate + *planar processing steps = multiple devices monolithically integrated

Si wafer



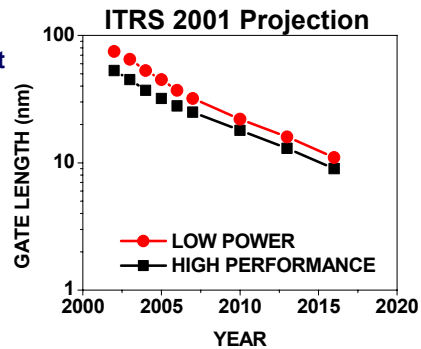
*sequence of **additive** and **subtractive** steps with **lateral patterning**



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IC Technology Advancement

Rapid advances in IC technology have been achieved primarily by scaling down transistor lateral dimensions

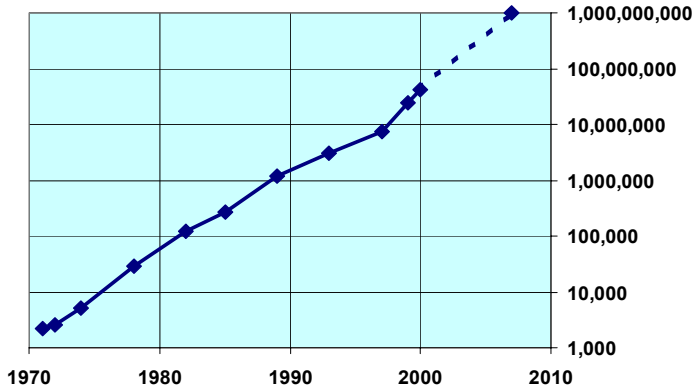


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Benefit of Transistor Scaling

“Moore’s Law”

transistors/chip doubles every 1.5 to 2 years



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Example: Microprocessor Evolution

Generation: 1.5μ 1.0μ 0.8μ 0.6μ 0.35μ 0.25μ

Intel386™ DX Processor



Intel486™ DX Processor



Pentium® Processor



Pentium® II Processor



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Semiconductor Fundamentals

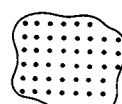
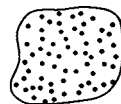
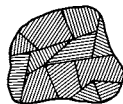
OUTLINE

- General material properties
- Crystal structure
- Bond model

Read: Chapter 1

What is a Semiconductor?

- Low resistivity => “conductor”
- High resistivity => “insulator”
- Intermediate resistivity => “semiconductor”
 - conductivity lies between that of conductors and insulators
 - generally crystalline in structure for IC devices
 - In recent years, however, non-crystalline semiconductors have become commercially very important



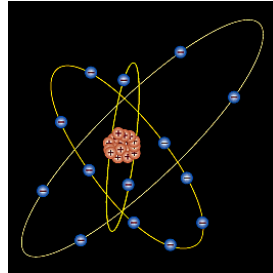
polycrystalline amorphous crystalline

The Silicon Atom

- 14 electrons occupying the 1st 3 energy levels:
 - 1s, 2s, 2p orbitals filled by 10 electrons
 - 3s, 3p orbitals filled by 4 electrons

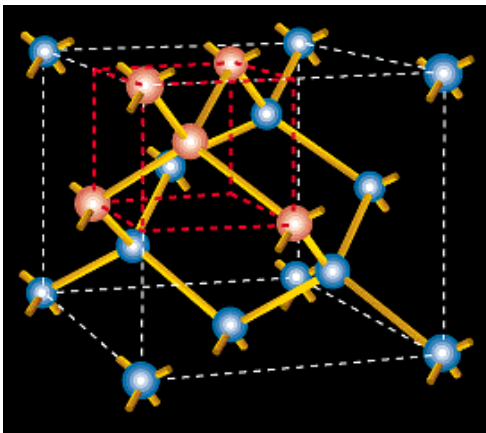
To minimize the overall energy, the 3s and 3p orbitals hybridize to form 4 tetrahedral 3sp orbitals

Each has one electron and is capable of forming a bond with a neighboring atom



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The Si Crystal

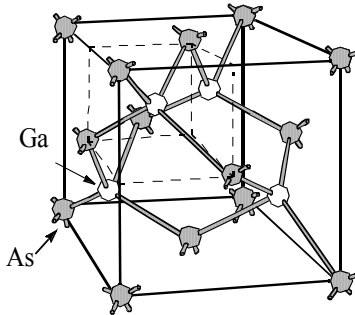


“diamond cubic” lattice

- Each Si atom has 4 nearest neighbors
- lattice constant = 5.431Å

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Compound Semiconductors



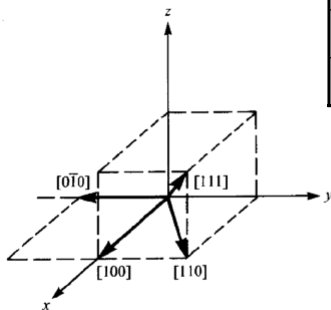
- “zincblende” structure
- III-V compound semiconductors: GaAs, GaP, GaN, *etc.*
 - ✓ important for optoelectronics and high-speed ICs

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Crystallographic Notation

Miller Indices:

Notation	Interpretation
$(h\ k\ l)$	crystal plane
$\{h\ k\ l\}$	equivalent planes
$[h\ k\ l]$	crystal direction
$\langle h\ k\ l \rangle$	equivalent directions



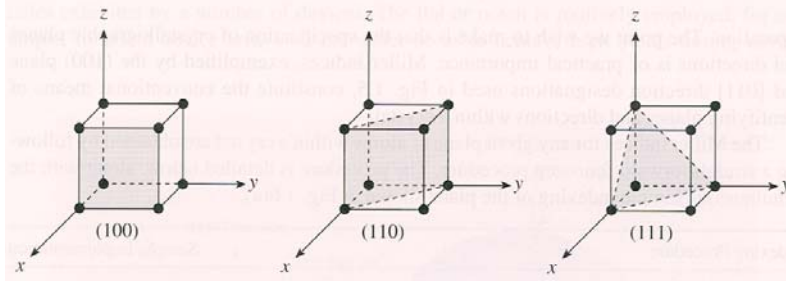
h: inverse *x*-intercept of plane
k: inverse *y*-intercept of plane
l: inverse *z*-intercept of plane

(Intercept values are in multiples of the lattice constant; *h*, *k* and *l* are reduced to 3 integers having the same ratio.)

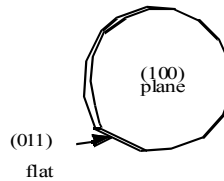
Sample direction vectors and their corresponding Miller indices.

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Crystallographic Planes and Si Wafers



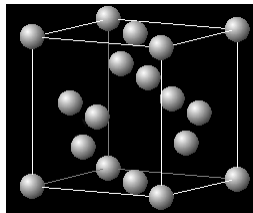
Silicon wafers are usually cut along the (100) plane with a flat or notch to orient the wafer during IC fabrication:



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Crystallographic Planes in Si

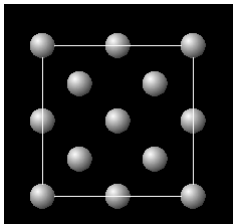
Unit cell:



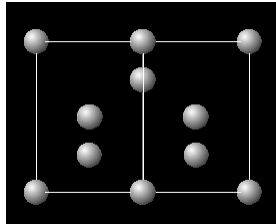
lattice constant = 5.431 \AA

$\rightarrow 5 \times 10^{22} \text{ atoms/cm}^3$

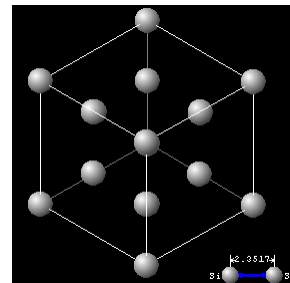
View in $\langle 100 \rangle$ direction



View in $\langle 110 \rangle$ direction



View in $\langle 111 \rangle$ direction



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Electronic Properties of Si

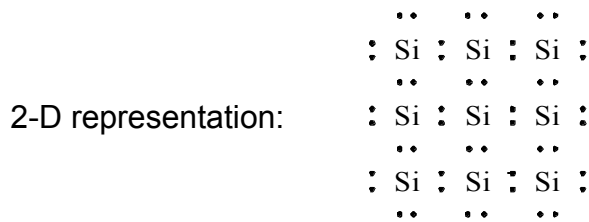
- **Silicon is a semiconductor material.**
 - Pure Si has a relatively high electrical resistivity at room temperature.

- **There are 2 types of mobile charge-carriers in Si:**
 - *Conduction electrons* are negatively charged;
 - *Holes* are positively charged.

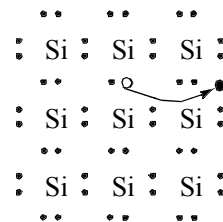
- **The concentration (#/cm³) of conduction electrons & holes in a semiconductor can be modulated in several ways:**
 1. by adding special impurity atoms (*dopants*)
 2. by applying an electric field
 3. by changing the temperature
 4. by irradiation

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Bond Model of Electrons and Holes



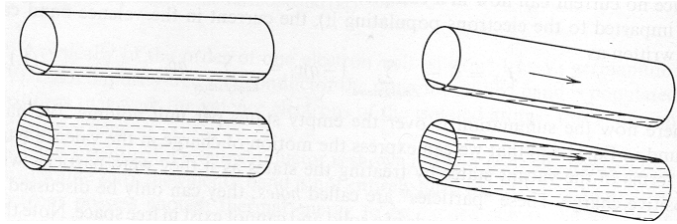
When an electron breaks loose and becomes a **conduction electron**, a **hole** is also created.



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What is a Hole?

- Mobile positive charge associated with a half-filled covalent bond
 - Treat as positively charged mobile particle in the semiconductor
- Fluid analogy:

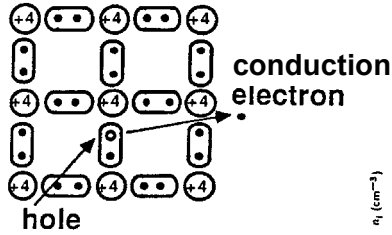


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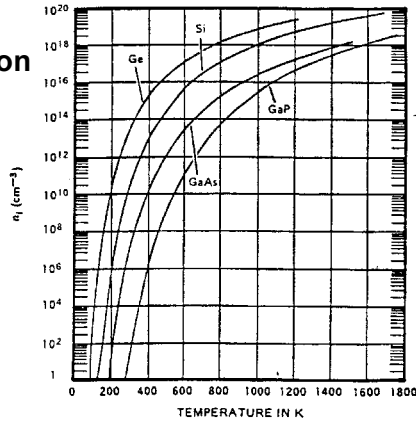
The Hole as a Positive Mobile Charge

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Pure Si



Covalent (shared e^-) bonds exist between Si atoms in a crystal. Since the e^- are loosely bound, some will be free at any T , creating hole electron pairs.



Si:

$$n_i = 3.9 \times 10^{16} T^{3/2} e^{-\frac{0.605\text{eV}}{kT}} / \text{cm}^3$$

$$n_i \cong 10^{10} \text{ cm}^{-3} \text{ at room temperature}$$

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Summary

- Crystalline Si:
 - 4 valence electrons per atom
 - diamond lattice: each atom has 4 nearest neighbors
 - 5×10^{22} atoms/ cm^3
- In a pure Si crystal, conduction electrons and holes are formed in pairs.
 - Holes can be considered as positively charged mobile particles which exist inside a semiconductor.
 - Both holes and electrons can conduct current.

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